FNMT-RCM Laboratory Test Directory



PAPER AND POLYMER

Paper and polymer

Grammage Thickness Tensile strength Folding resistance Tear resistance Ash content Coating properties Smoothness Porosity Roughness Porometry Whiteness Optical opacity Colour UV luminescence Surface resistance Printability Ageing Stiffness and bending Fibres composition Paper fillers Absolute moisture Misalignment Watermarks

Magnetism and security thread coding

INKS AND VARNISHES

Inks and varnishes

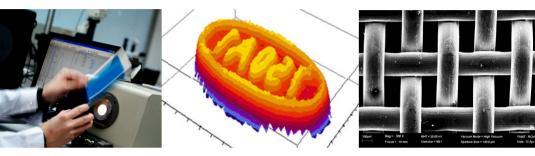
Colour Fluorescence Phosphorescence Magnetism Opacity by printing Ink printability Peeling Drvina Stiffness Viscositv Infrared transparency Gloss Optical density Optically variable and iridescent (OVI) inks Surface tensile strength Chemical analysis by SEM/EDX, EDXRF or FTIR Test Print Centre Offset. intaglio. silk-screen printing, letterpress, foil application.

ID DOCUMENTS AND OTHER MEANS OF PAYMENT

Cards and passports

Study of composition by means of the following tests: Chemical Organoleptic Infrared spectrometry FTIR + microscope Study of properties in different atmospheric conditions: Chambers: environmental, light, thermal shock, saline fog Study of security elements, including: Visual light test: Ultraviolet, infrared, polarised, etc. Magnetic stripe Embossed relief Electrical properties, card with and without contact (RFID) Adhesion of inks on plastic supports:





Adhesion, friction resistance Adhesives: Adhesion, Shear, Ageing

BANKNOTES AND OTHER SECURITY PRODUCTS

Resistance and ageing

Abrasion resistance Drv and wet crumpling Heat resistance Light resistance Chemical resistance Foil or patch resistance Resistance by the application of adhesive tapes Ironing resistance Freezing resistance Ball-vibration resistance Washing machine resistance Lightfastness Abrasion resistance Soiling resistance Ad hoc developments of new testing procedures

Characterization

SEM/EDX. Surface and transversal analysis Confocal- interferometry Relief surface analysis

COINS, METALS AND OTHER

ICP- OES Technique

Analysis of pollutants in the air Analysis of waste water Analysis of copper-based alloy metals

Atomic Absorption (AA) Base allovs:

Copper, iron, nickel, aluminium, lead, zinc and tin

Optical Emission Spectrometry (OES)

Base alloys:

Copper, aluminium, iron Impurities in pure metals (Cu and Ni)

SEM/EDX

Blanks and coins Gold and silver alloys Potentiometry

Silver allovs

Silver monetary alloys (900 - 950 ‰). Accredited by ENAC

Cupellation

Analysis of Au-based alloys Gold monetary alloys and fine gold (880 - 920 ‰ / 990 - 999,9 ‰). Accredited by ENAC

Other

Brinell, Rockwell and Vickers hardness Metallographic testing Magnetism Electrical behaviour

ADDED VALUE

Environment and Health and Safety

In air: Metals, Organic vapours In waste water: COD (Chemical Oxygen Demand), metals, organic vapours, cations, anions, pH

Metrology and calibration: Dimensions, temperature and

relative humidity, mass.